

30V N-CHANNEL ENHANCEMENT MODE MOSFET IN SOT23

Product Summary

V _{(BR)DSS}	Max R _{DS(on)}	I _D Max (Note 5) T _A = 25°C
30V	460mΩ @ V _{GS} = 4.5V	0.94A
	560mΩ @ V _{GS} = 2.5V	0.85A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Load switch
- Portable applications
- **Power Management Functions**

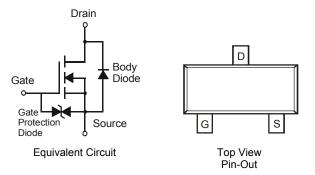
Features and Benefits

- Low V_{GS(th),} can be driven directly from a battery
- Low R_{DS(on)}
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- **ESD Protected Gate 2kV**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish-Matte Tin.
- Weight: 0.08 grams (approximate)





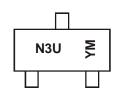
Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN3730U-7	N3U	7	8	3,000

Notes:

- 1. No purposefully added lead
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



N3U = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	2011	1	2012		2013	20	14	2015		2016		2017
Code	Υ		Z		Α	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings @TA = 25°C unless otherwise specified

Cha	aracteristic		Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current	Steady T _A = 25°C (Note 5)		I _D	0.94 0.68 0.75	А
Pulsed Drain Current (Note 6))		I _{DM}	10	A

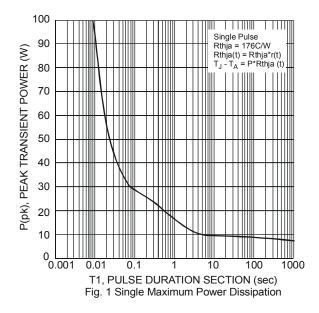
Thermal Characteristics @TA = 25°C unless otherwise specified

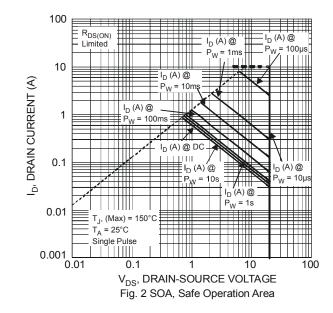
Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 4)	D	0.45	W
Power Dissipation	(Note 5)	P_D	0.45 0.71 275	W
Thermal Resistance, Junction to Ambient	(Note 4)	D	275	°C/W
	(Note 5)	$R_{ heta JA}$	177	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

Notes:

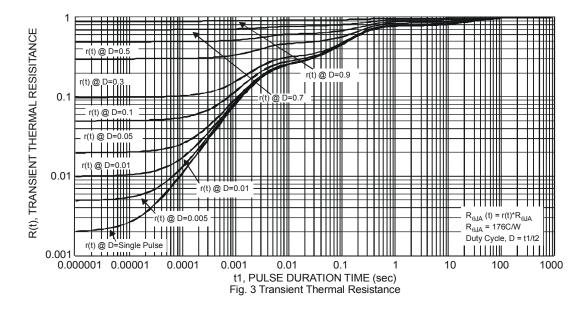
- 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
- 5. Device mounted on 25mm X 25mm square copper plate with FR-4 substrate PC board, 2oz copper
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

Thermal Characteristics









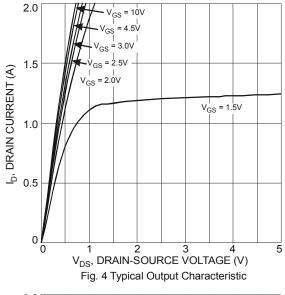
Electrical Characteristics @TA = 25°C unless otherwise specified

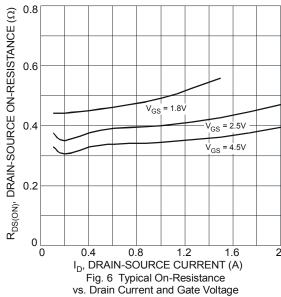
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_{D} = 10\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1	μΑ	V _{DS} = 30V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	-	-	3	μА	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	0.45	ı	0.95	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
				460		$V_{GS} = 4.5V, I_D = 200mA$	
Static Drain-Source On-Resistance (Note 7)	R _{DS(on)}	-	-	560	$m\Omega$	$V_{GS} = 2.5V, I_D = 100mA$	
	, ,			730	İ	V _{GS} = 1.8V, I _D = 75mA	
Forward Transfer Admittance	Y _{fs}	40	-	-	mS	V _{DS} = 3V, I _D = 10mA	
Diode Forward Voltage (Note 7)	V _{SD}	-	0.7	1.2	V	V _{GS} = 0V, I _S = 300mA	
DYNAMIC CHARACTERISTICS (Note 8)				•			
Input Capacitance	C _{iss}	ı	64.3	-	рF	V 05V V 0V	
Output Capacitance	Coss	-	6.1	-	pF	$V_{DS} = 25V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	4.5	-	pF	1 = 1.0WHZ	
Gate Resistance	Rg	-	70	-	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz	
Total Gate Charge	Qg	-	1.6	-	nC	V 45V V 45V	
Gate-Source Charge	Q _{gs}	-	0.2	-	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$	
Gate-Drain Charge	Q _{gd}	-	0.2	-	nC	I _D = 1A	
Turn-On Delay Time	t _{D(on)}	-	3.5	-	ns		
Turn-On Rise Time	t _r	-	2.8	-	ns	V _{DS} = 10V, I _D = 1A	
Turn-Off Delay Time	t _{D(off)}	-	38	-	ns	V_{GS} = 10V, R_G = 6 Ω	
Turn-Off Fall Time	t _f	-	13	-	ns		

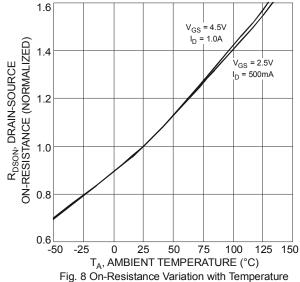
Notes: 7. Measured under pulsed conditions to minimize self-heating effect. Pulse width $\leq 300 \mu s$; duty cycle $\leq 2\%$

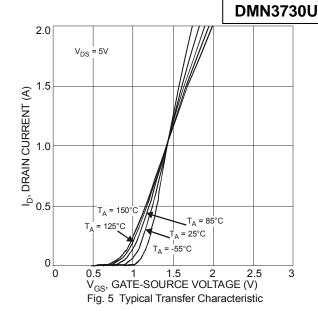
8. For design aid only, not subject to production testing.

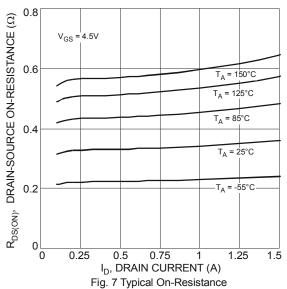


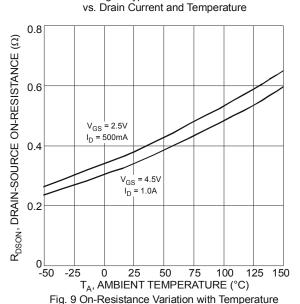
















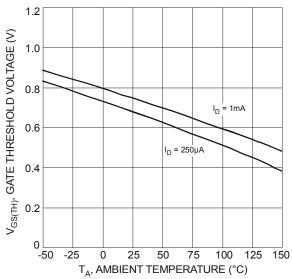
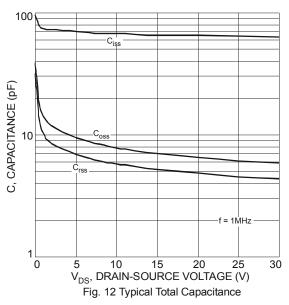
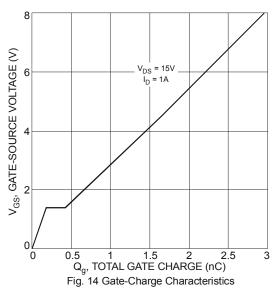
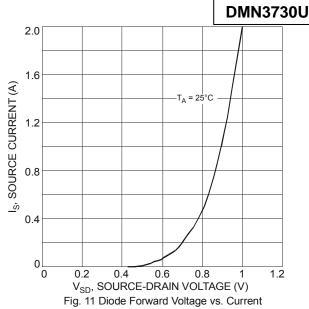
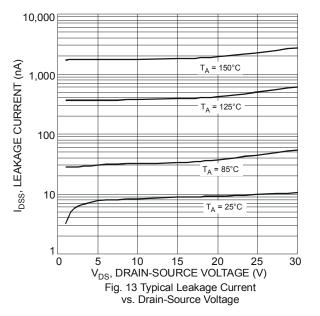


Fig. 10 Gate Threshold Variation vs. Ambient Temperature



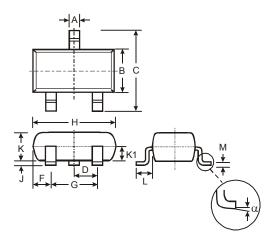






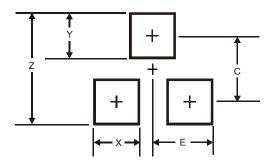


Package Outline Dimensions



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	-	1	0.400				
L	0.45	0.61	0.55				
M	0.085	0.18	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
Е	1.35





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